

CMOS Digital Integrated Circuits Silicon Monolithic

TC74VCX32FK

1. Functional Description

Low-Voltage Quad 2-Input OR Gate with 3.6-V Tolerant Inputs and Outputs

2. General

The TC74VCX32FK is a high-performance CMOS 2-input OR gate which is guaranteed to operate from 1.2 V to 3.6 V.

Designed for use in 1.5 V, 1.8 V, 2.5 V or 3.3 V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to 3.6 V.

All inputs are equipped with protection circuits against static discharge.

3. Features

- (1) Low-voltage operation: V_{CC} = 1.2 to 3.6 V
- (2) High-speed operation: $t_{pd} = 2.8 \text{ ns} (\text{max}) (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$

$$t_{pd}$$
 = 14.8 ns (max) (V_{CC} = 1.4 to 1.6 V)

$$t_{pd}$$
 = 37.0 ns (max) (V_{CC} = 1.2 V)

(3) Output current: $I_{OH}/I_{OL} = \pm 24 \text{ mA} \text{ (min)} (V_{CC} = 3.0 \text{ V})$

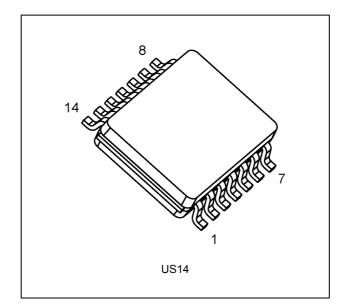
$$I_{OH}/I_{OL} = \pm 18 \text{ mA} \text{ (min)} (V_{CC} = 2.3 \text{ V})$$

$$I_{OH}/I_{OL} = \pm 6 \text{ mA} \text{ (min)} (V_{CC} = 1.65 \text{ V})$$

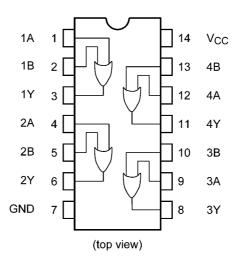
$$I_{OH}/I_{OL} = \pm 2 \text{ mA} \text{ (min)} (V_{CC} = 1.4 \text{ V})$$

- (4) Latch-up performance: -300 mA
- (5) ESD performance: Human Body Model $\ge \pm 2000 \text{ V}$
- (6) 3.6 V tolerant function and power-down protection provided on all inputs and outputs.

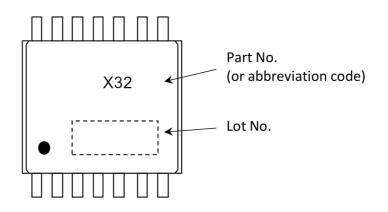
4. Packaging



5. Pin Assignment



6. Marking



7. Block Diagram

1A <u>(1)</u> 1B <u>(2)</u>	≥ 1	(<u>3)</u> 1Y
2A <u>(4)</u> 2B <u>(5)</u>		<u>(6)</u> 2Y
3A <u>(9)</u> 3B <u>(10)</u>		<u>(8)</u> 3Y
4A <u>(12)</u> 4B <u>(13)</u>		<u>(11)</u> 4Y

8. Truth Table

Inputs A	Inputs B	Outputs Y
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 4.6	V
Input voltage	V _{IN}		-0.5 to 4.6	V
Output voltage	V _{OUT}	(Note 1)	-0.5 to 4.6	V
		(Note 2)	-0.5 to V _{CC} + 0.5	
Input diode current	I _{IK}		-50	mA
Output diode current	I _{ОК}	(Note 3)	±50	mA
Output current	I _{OUT}		±50	mA
Power dissipation	PD		180	mW
V _{CC} /ground current	I _{CC} /I _{GND}		±100	mA
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: V_{CC} = 0 V

Note 2: High (H) or Low (L) state. IOUT absolute maximum rating must be observed.

Note 3: V_{OUT} < GND, V_{OUT} > V_{CC}

10. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		1.2 to 3.6	V
Input voltage	V _{IN}		-0.3 to 3.6	V
Output voltage	V _{OUT}	(Note 1)	0 to 3.6	V
		(Note 2)	0 to V _{CC}	
Output current	I _{OH} ,I _{OL}	(Note 3)	±24	mA
		(Note 4)	±18	
		(Note 5)	±6	
		(Note 6)	±2	
Operating temperature	T _{opr}		-40 to 85	°C
Input rise and fall times	dt/dv	(Note 7)	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Note 1: $V_{CC} = 0 V$

Note 2: High (H) or Low (L) state. Note 3: V_{CC} = 3.0 to 3.6 V Note 4: V_{CC} = 2.3 to 2.7 V Note 5: V_{CC} = 1.65 to 1.95 V Note 6: V_{CC} = 1.4 to 1.6 V Note 7: V_{IN} = 0.8 to 2.0 V, V_{CC} = 3.0 V

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Conditi	on	V _{CC} (V)	Min	Max	Unit
High-level input voltage	VIH	—		1.2 to 1.4	$V_{CC} \times 0.8$	—	V
				1.4 to 1.65	$V_{CC} imes 0.65$	—	
				1.65 to 2.3	$V_{CC} imes 0.65$	_	
				2.3 to 2.7	1.6	_	
				2.7 to 3.6	2.0	_	
Low-level input voltage	VIL	—		1.2 to 1.4	_	$V_{CC} imes 0.05$	V
				1.4 to 1.65	_	$V_{CC} imes 0.05$	
				1.65 to 2.3	_	$V_{CC} \times 0.2$	
				2.3 to 2.7	—	0.7	
				2.7 to 3.6	_	0.8	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.2	V _{CC} - 0.1	—	V
				1.4 to 1.65	V _{CC} - 0.2	—	
				1.65 to 3.6	V _{CC} - 0.2	_	
			I _{OH} = -2 mA	1.4	1.05	_	
			I _{OH} = -6 mA	1.65	1.25	_	
				2.3	2.0	_	
			I _{OH} = -12 mA	2.3	1.8	_	
				2.7	2.2	_	
			I _{OH} = -18 mA	2.3	1.7	_	
				3.0	2.4	_	
			I _{OH} = -24 mA	3.0	2.2	—	
Low-level output voltage	V _{OL}	V _{IN} = V _{IL}	I _{OL} = 100 μA	1.2	_	0.05	V
				1.4 to 1.65	_	0.05	
				1.65 to 3.6	_	0.2	
			I _{OL} = 2 mA	1.4	_	0.35	
			I _{OL} = 6 mA	1.65	_	0.3	
			I _{OL} = 12 mA	2.3	_	0.4	
				2.7	_	0.4	
			I _{OL} = 18 mA	2.3	—	0.6	
				3.0	_	0.4	
			I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 0 to 3.6 V	•	1.2 to 3.6	—	±5.0	μA
Power-OFF leakage current	I _{OFF}	V _{IN} /V _{OUT} = 0 to 3.6 V		0	_	10.0	μA
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		1.2 to 3.6		20.0	μA
		$V_{CC} \le V_{IN} \le 3.6 \text{ V}$		1.2 to 3.6		±20.0	
	Δl _{CC}	V _{IH} = V _{CC} - 0.6 V (per input)		2.7 to 3.6	_	750	μA

11.2. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit				
Propagation delay time	t _{PLH} ,t _{PHL}		See 11.5 AC Test Circuit,	1.2	3.0	37.0	ns				
			Fig. 11.6.1, Table 11.6.1	1.5 ± 0.1	2.0	14.8					
				1.8 ± 0.15	1.5	7.4					
								$\textbf{2.5}\pm\textbf{0.2}$	0.8	3.7	
				$\textbf{3.3}\pm\textbf{0.3}$	0.6	2.8					
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	1.2	_	1.5	ns				
				1.5 ± 0.1	_	1.5					
				1.8 ± 0.15	_	0.5					
				2.5 ± 0.2	_	0.5					
				$\textbf{3.3}\pm\textbf{0.3}$	_	0.5					

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$

11.3. Dynamic Switching Characteristics (Note) (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	0.25	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	0.6	1
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	
Quiet output minimum dynamic V_{OL}	V _{OLV}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	-0.25	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	-0.6	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	-0.8	
Quiet output minimum dynamic V_{OH}	V _{OHV}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	1.5	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	1.9]
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	2.2	

Note: Parameter guaranteed by design.

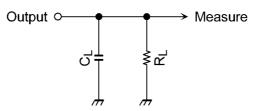
11.4. Capacitive Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}		—	1.8, 2.5, 3.3	6	pF
Power dissipation capacitance	C _{PD}	(Note 1)	f _{IN} = 10 MHz	1.8, 2.5, 3.3	20	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/4 \text{ (per gate)}$

11.5. AC Test Ciruict



11.6. AC Waveform

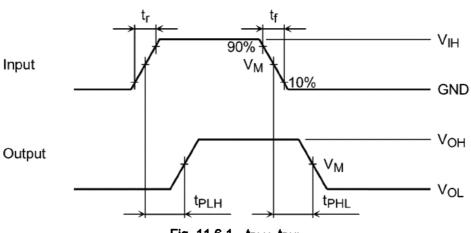


Fig. 11.6.1 tPLH, tPHL

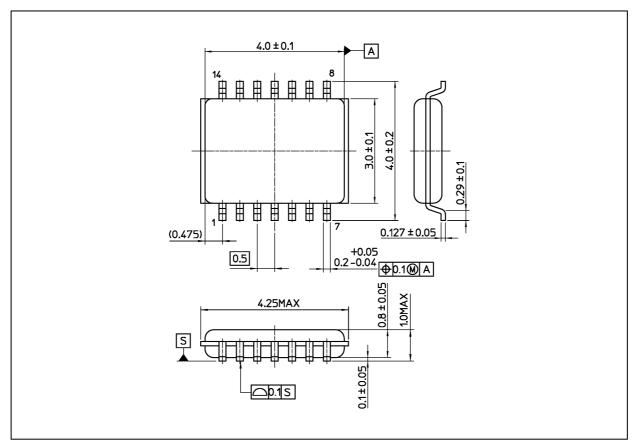
Table 11.6.1	AC Waveform Symbols
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	Symbol	V_{CC} = 3.3 \pm 0.3 V	V_{CC} = 2.5 ± 0.2 V V_{CC} = 1.8 ± 0.15 V	V_{CC} = 1.5 ± 0.1 V V_{CC} = 1.2 V
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}
	V _M	1.5 V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.0 ns	2.0 ns	2.0 ns
Output	V _M	1.5 V	V _{CC} /2	V _{CC} /2
Load	CL	30 pF	30 pF	15 pF
	RL	500 Ω	500 Ω	2 kΩ

TC74VCX32FK

Package Dimensions

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)				
TOSHIBA: VSSOP14-P-0030-0.50S				
Nickname: US14				

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